

Global High Thermal Conductivity Sintering Die Attach Adhesives Supply, Demand and Key Producers, 2023-2029

<https://marketpublishers.com/r/GA82B60C9EFEEN.html>

Date: July 2023

Pages: 120

Price: US\$ 4,480.00 (Single User License)

ID: GA82B60C9EFEEN

Abstracts

The global High Thermal Conductivity Sintering Die Attach Adhesives market size is expected to reach \$ 232.5 million by 2029, rising at a market growth of 4.6% CAGR during the forecast period (2023-2029).

Silver Sintering Paste is a kind of high silver-filled die attach paste, which can achieve ultra-high thermal conductivity. Silver sintered pastes offer a robust lead-free alternative to solder pastes increasing the lifetime of the device up to 10 times. It can be applied to printing or dispensing processes, which can ensure higher thermal conductivity in lead frame and LED packaging applications.

This report studies the global High Thermal Conductivity Sintering Die Attach Adhesives production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for High Thermal Conductivity Sintering Die Attach Adhesives, and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2022 as the base year. This report explores demand trends and competition, as well as details the characteristics of High Thermal Conductivity Sintering Die Attach Adhesives that contribute to its increasing demand across many markets.

Highlights and key features of the study

Global High Thermal Conductivity Sintering Die Attach Adhesives total production and demand, 2018-2029, (Kg)

Global High Thermal Conductivity Sintering Die Attach Adhesives total production value, 2018-2029, (USD Million)

Global High Thermal Conductivity Sintering Die Attach Adhesives production by region & country, production, value, CAGR, 2018-2029, (USD Million) & (Kg)

Global High Thermal Conductivity Sintering Die Attach Adhesives consumption by region & country, CAGR, 2018-2029 & (Kg)

U.S. VS China: High Thermal Conductivity Sintering Die Attach Adhesives domestic production, consumption, key domestic manufacturers and share

Global High Thermal Conductivity Sintering Die Attach Adhesives production by manufacturer, production, price, value and market share 2018-2023, (USD Million) & (Kg)

Global High Thermal Conductivity Sintering Die Attach Adhesives production by Type, production, value, CAGR, 2018-2029, (USD Million) & (Kg)

Global High Thermal Conductivity Sintering Die Attach Adhesives production by Application production, value, CAGR, 2018-2029, (USD Million) & (Kg)

This reports profiles key players in the global High Thermal Conductivity Sintering Die Attach Adhesives market based on the following parameters – company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Heraeus, Kyocera, Indium, Alpha Assembly Solutions, Henkel, Namics, Advanced Joining Technology, Shenzhen Facemoore Technology and Beijing Nanotop Electronic Technology, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals, COVID-19 and Russia-Ukraine War Influence.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World High Thermal Conductivity Sintering Die Attach Adhesives market

Detailed Segmentation:

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (Kg) and average price (US\$/g) by manufacturer, by Type, and by Application. Data is given for the years 2018-2029 by year with 2022 as the base year, 2023 as the estimate year, and 2024-2029 as the forecast year.

Global High Thermal Conductivity Sintering Die Attach Adhesives Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

Global High Thermal Conductivity Sintering Die Attach Adhesives Market, Segmentation by Type

Pressure Sintering

Pressure-less Sintering

Global High Thermal Conductivity Sintering Die Attach Adhesives Market, Segmentation by Application

Power Semiconductor Device

RF Power Device

High Performance LED

Others

Companies Profiled:

Heraeus

Kyocera

Indium

Alpha Assembly Solutions

Henkel

Namics

Advanced Joining Technology

Shenzhen Facemoore Technology

Beijing Nanotop Electronic Technology

TANAKA Precious Metals

Nihon Superior

Nihon Handa

NBE Tech

Solderwell Advanced Materials

Guangzhou Xianyi Electronic Technology

ShareX (Zhejiang) New Material Technology

Bando Chemical Industries

Key Questions Answered

1. How big is the global High Thermal Conductivity Sintering Die Attach Adhesives market?
2. What is the demand of the global High Thermal Conductivity Sintering Die Attach Adhesives market?
3. What is the year over year growth of the global High Thermal Conductivity Sintering Die Attach Adhesives market?
4. What is the production and production value of the global High Thermal Conductivity Sintering Die Attach Adhesives market?
5. Who are the key producers in the global High Thermal Conductivity Sintering Die Attach Adhesives market?
6. What are the growth factors driving the market demand?

Contents

1 SUPPLY SUMMARY

- 1.1 High Thermal Conductivity Sintering Die Attach Adhesives Introduction
- 1.2 World High Thermal Conductivity Sintering Die Attach Adhesives Supply & Forecast
 - 1.2.1 World High Thermal Conductivity Sintering Die Attach Adhesives Production Value (2018 & 2022 & 2029)
 - 1.2.2 World High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2029)
 - 1.2.3 World High Thermal Conductivity Sintering Die Attach Adhesives Pricing Trends (2018-2029)
- 1.3 World High Thermal Conductivity Sintering Die Attach Adhesives Production by Region (Based on Production Site)
 - 1.3.1 World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Region (2018-2029)
 - 1.3.2 World High Thermal Conductivity Sintering Die Attach Adhesives Production by Region (2018-2029)
 - 1.3.3 World High Thermal Conductivity Sintering Die Attach Adhesives Average Price by Region (2018-2029)
 - 1.3.4 North America High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2029)
 - 1.3.5 Europe High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2029)
 - 1.3.6 China High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2029)
 - 1.3.7 Japan High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2029)
- 1.4 Market Drivers, Restraints and Trends
 - 1.4.1 High Thermal Conductivity Sintering Die Attach Adhesives Market Drivers
 - 1.4.2 Factors Affecting Demand
 - 1.4.3 High Thermal Conductivity Sintering Die Attach Adhesives Major Market Trends
- 1.5 Influence of COVID-19 and Russia-Ukraine War
 - 1.5.1 Influence of COVID-19
 - 1.5.2 Influence of Russia-Ukraine War

2 DEMAND SUMMARY

- 2.1 World High Thermal Conductivity Sintering Die Attach Adhesives Demand

(2018-2029)

2.2 World High Thermal Conductivity Sintering Die Attach Adhesives Consumption by Region

2.2.1 World High Thermal Conductivity Sintering Die Attach Adhesives Consumption by Region (2018-2023)

2.2.2 World High Thermal Conductivity Sintering Die Attach Adhesives Consumption Forecast by Region (2024-2029)

2.3 United States High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029)

2.4 China High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029)

2.5 Europe High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029)

2.6 Japan High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029)

2.7 South Korea High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029)

2.8 ASEAN High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029)

2.9 India High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029)

3 WORLD HIGH THERMAL CONDUCTIVITY SINTERING DIE ATTACH ADHESIVES MANUFACTURERS COMPETITIVE ANALYSIS

3.1 World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Manufacturer (2018-2023)

3.2 World High Thermal Conductivity Sintering Die Attach Adhesives Production by Manufacturer (2018-2023)

3.3 World High Thermal Conductivity Sintering Die Attach Adhesives Average Price by Manufacturer (2018-2023)

3.4 High Thermal Conductivity Sintering Die Attach Adhesives Company Evaluation Quadrant

3.5 Industry Rank and Concentration Rate (CR)

3.5.1 Global High Thermal Conductivity Sintering Die Attach Adhesives Industry Rank of Major Manufacturers

3.5.2 Global Concentration Ratios (CR4) for High Thermal Conductivity Sintering Die Attach Adhesives in 2022

3.5.3 Global Concentration Ratios (CR8) for High Thermal Conductivity Sintering Die

Attach Adhesives in 2022

3.6 High Thermal Conductivity Sintering Die Attach Adhesives Market: Overall Company Footprint Analysis

3.6.1 High Thermal Conductivity Sintering Die Attach Adhesives Market: Region Footprint

3.6.2 High Thermal Conductivity Sintering Die Attach Adhesives Market: Company Product Type Footprint

3.6.3 High Thermal Conductivity Sintering Die Attach Adhesives Market: Company Product Application Footprint

3.7 Competitive Environment

3.7.1 Historical Structure of the Industry

3.7.2 Barriers of Market Entry

3.7.3 Factors of Competition

3.8 New Entrant and Capacity Expansion Plans

3.9 Mergers, Acquisition, Agreements, and Collaborations

4 UNITED STATES VS CHINA VS REST OF THE WORLD

4.1 United States VS China: High Thermal Conductivity Sintering Die Attach Adhesives Production Value Comparison

4.1.1 United States VS China: High Thermal Conductivity Sintering Die Attach Adhesives Production Value Comparison (2018 & 2022 & 2029)

4.1.2 United States VS China: High Thermal Conductivity Sintering Die Attach Adhesives Production Value Market Share Comparison (2018 & 2022 & 2029)

4.2 United States VS China: High Thermal Conductivity Sintering Die Attach Adhesives Production Comparison

4.2.1 United States VS China: High Thermal Conductivity Sintering Die Attach Adhesives Production Comparison (2018 & 2022 & 2029)

4.2.2 United States VS China: High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share Comparison (2018 & 2022 & 2029)

4.3 United States VS China: High Thermal Conductivity Sintering Die Attach Adhesives Consumption Comparison

4.3.1 United States VS China: High Thermal Conductivity Sintering Die Attach Adhesives Consumption Comparison (2018 & 2022 & 2029)

4.3.2 United States VS China: High Thermal Conductivity Sintering Die Attach Adhesives Consumption Market Share Comparison (2018 & 2022 & 2029)

4.4 United States Based High Thermal Conductivity Sintering Die Attach Adhesives Manufacturers and Market Share, 2018-2023

4.4.1 United States Based High Thermal Conductivity Sintering Die Attach Adhesives

Manufacturers, Headquarters and Production Site (States, Country)

4.4.2 United States Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Value (2018-2023)

4.4.3 United States Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2023)

4.5 China Based High Thermal Conductivity Sintering Die Attach Adhesives Manufacturers and Market Share

4.5.1 China Based High Thermal Conductivity Sintering Die Attach Adhesives Manufacturers, Headquarters and Production Site (Province, Country)

4.5.2 China Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Value (2018-2023)

4.5.3 China Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2023)

4.6 Rest of World Based High Thermal Conductivity Sintering Die Attach Adhesives Manufacturers and Market Share, 2018-2023

4.6.1 Rest of World Based High Thermal Conductivity Sintering Die Attach Adhesives Manufacturers, Headquarters and Production Site (State, Country)

4.6.2 Rest of World Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Value (2018-2023)

4.6.3 Rest of World Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2023)

5 MARKET ANALYSIS BY TYPE

5.1 World High Thermal Conductivity Sintering Die Attach Adhesives Market Size Overview by Type: 2018 VS 2022 VS 2029

5.2 Segment Introduction by Type

5.2.1 Pressure Sintering

5.2.2 Pressure-less Sintering

5.3 Market Segment by Type

5.3.1 World High Thermal Conductivity Sintering Die Attach Adhesives Production by Type (2018-2029)

5.3.2 World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Type (2018-2029)

5.3.3 World High Thermal Conductivity Sintering Die Attach Adhesives Average Price by Type (2018-2029)

6 MARKET ANALYSIS BY APPLICATION

6.1 World High Thermal Conductivity Sintering Die Attach Adhesives Market Size
Overview by Application: 2018 VS 2022 VS 2029

6.2 Segment Introduction by Application

6.2.1 Power Semiconductor Device

6.2.2 RF Power Device

6.2.3 High Performance LED

6.2.4 Others

6.3 Market Segment by Application

6.3.1 World High Thermal Conductivity Sintering Die Attach Adhesives Production by Application (2018-2029)

6.3.2 World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Application (2018-2029)

6.3.3 World High Thermal Conductivity Sintering Die Attach Adhesives Average Price by Application (2018-2029)

7 COMPANY PROFILES

7.1 Heraeus

7.1.1 Heraeus Details

7.1.2 Heraeus Major Business

7.1.3 Heraeus High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

7.1.4 Heraeus High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.1.5 Heraeus Recent Developments/Updates

7.1.6 Heraeus Competitive Strengths & Weaknesses

7.2 Kyocera

7.2.1 Kyocera Details

7.2.2 Kyocera Major Business

7.2.3 Kyocera High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

7.2.4 Kyocera High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.2.5 Kyocera Recent Developments/Updates

7.2.6 Kyocera Competitive Strengths & Weaknesses

7.3 Indium

7.3.1 Indium Details

7.3.2 Indium Major Business

7.3.3 Indium High Thermal Conductivity Sintering Die Attach Adhesives Product and

Services

7.3.4 Indium High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.3.5 Indium Recent Developments/Updates

7.3.6 Indium Competitive Strengths & Weaknesses

7.4 Alpha Assembly Solutions

7.4.1 Alpha Assembly Solutions Details

7.4.2 Alpha Assembly Solutions Major Business

7.4.3 Alpha Assembly Solutions High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

7.4.4 Alpha Assembly Solutions High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.4.5 Alpha Assembly Solutions Recent Developments/Updates

7.4.6 Alpha Assembly Solutions Competitive Strengths & Weaknesses

7.5 Henkel

7.5.1 Henkel Details

7.5.2 Henkel Major Business

7.5.3 Henkel High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

7.5.4 Henkel High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.5.5 Henkel Recent Developments/Updates

7.5.6 Henkel Competitive Strengths & Weaknesses

7.6 Namics

7.6.1 Namics Details

7.6.2 Namics Major Business

7.6.3 Namics High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

7.6.4 Namics High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.6.5 Namics Recent Developments/Updates

7.6.6 Namics Competitive Strengths & Weaknesses

7.7 Advanced Joining Technology

7.7.1 Advanced Joining Technology Details

7.7.2 Advanced Joining Technology Major Business

7.7.3 Advanced Joining Technology High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

7.7.4 Advanced Joining Technology High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)

- 7.7.5 Advanced Joining Technology Recent Developments/Updates
- 7.7.6 Advanced Joining Technology Competitive Strengths & Weaknesses
- 7.8 Shenzhen Facemoore Technology
 - 7.8.1 Shenzhen Facemoore Technology Details
 - 7.8.2 Shenzhen Facemoore Technology Major Business
 - 7.8.3 Shenzhen Facemoore Technology High Thermal Conductivity Sintering Die Attach Adhesives Product and Services
 - 7.8.4 Shenzhen Facemoore Technology High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)
 - 7.8.5 Shenzhen Facemoore Technology Recent Developments/Updates
 - 7.8.6 Shenzhen Facemoore Technology Competitive Strengths & Weaknesses
- 7.9 Beijing Nanotop Electronic Technology
 - 7.9.1 Beijing Nanotop Electronic Technology Details
 - 7.9.2 Beijing Nanotop Electronic Technology Major Business
 - 7.9.3 Beijing Nanotop Electronic Technology High Thermal Conductivity Sintering Die Attach Adhesives Product and Services
 - 7.9.4 Beijing Nanotop Electronic Technology High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)
 - 7.9.5 Beijing Nanotop Electronic Technology Recent Developments/Updates
 - 7.9.6 Beijing Nanotop Electronic Technology Competitive Strengths & Weaknesses
- 7.10 TANAKA Precious Metals
 - 7.10.1 TANAKA Precious Metals Details
 - 7.10.2 TANAKA Precious Metals Major Business
 - 7.10.3 TANAKA Precious Metals High Thermal Conductivity Sintering Die Attach Adhesives Product and Services
 - 7.10.4 TANAKA Precious Metals High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)
 - 7.10.5 TANAKA Precious Metals Recent Developments/Updates
 - 7.10.6 TANAKA Precious Metals Competitive Strengths & Weaknesses
- 7.11 Nihon Superior
 - 7.11.1 Nihon Superior Details
 - 7.11.2 Nihon Superior Major Business
 - 7.11.3 Nihon Superior High Thermal Conductivity Sintering Die Attach Adhesives Product and Services
 - 7.11.4 Nihon Superior High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)
 - 7.11.5 Nihon Superior Recent Developments/Updates

- 7.11.6 Nihon Superior Competitive Strengths & Weaknesses
- 7.12 Nihon Handa
 - 7.12.1 Nihon Handa Details
 - 7.12.2 Nihon Handa Major Business
 - 7.12.3 Nihon Handa High Thermal Conductivity Sintering Die Attach Adhesives Product and Services
 - 7.12.4 Nihon Handa High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)
 - 7.12.5 Nihon Handa Recent Developments/Updates
 - 7.12.6 Nihon Handa Competitive Strengths & Weaknesses
- 7.13 NBE Tech
 - 7.13.1 NBE Tech Details
 - 7.13.2 NBE Tech Major Business
 - 7.13.3 NBE Tech High Thermal Conductivity Sintering Die Attach Adhesives Product and Services
 - 7.13.4 NBE Tech High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)
 - 7.13.5 NBE Tech Recent Developments/Updates
 - 7.13.6 NBE Tech Competitive Strengths & Weaknesses
- 7.14 Solderwell Advanced Materials
 - 7.14.1 Solderwell Advanced Materials Details
 - 7.14.2 Solderwell Advanced Materials Major Business
 - 7.14.3 Solderwell Advanced Materials High Thermal Conductivity Sintering Die Attach Adhesives Product and Services
 - 7.14.4 Solderwell Advanced Materials High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)
 - 7.14.5 Solderwell Advanced Materials Recent Developments/Updates
 - 7.14.6 Solderwell Advanced Materials Competitive Strengths & Weaknesses
- 7.15 Guangzhou Xianyi Electronic Technology
 - 7.15.1 Guangzhou Xianyi Electronic Technology Details
 - 7.15.2 Guangzhou Xianyi Electronic Technology Major Business
 - 7.15.3 Guangzhou Xianyi Electronic Technology High Thermal Conductivity Sintering Die Attach Adhesives Product and Services
 - 7.15.4 Guangzhou Xianyi Electronic Technology High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)
 - 7.15.5 Guangzhou Xianyi Electronic Technology Recent Developments/Updates
 - 7.15.6 Guangzhou Xianyi Electronic Technology Competitive Strengths & Weaknesses
- 7.16 ShareX (Zhejiang) New Material Technology

- 7.16.1 ShareX (Zhejiang) New Material Technology Details
- 7.16.2 ShareX (Zhejiang) New Material Technology Major Business
- 7.16.3 ShareX (Zhejiang) New Material Technology High Thermal Conductivity Sintering Die Attach Adhesives Product and Services
- 7.16.4 ShareX (Zhejiang) New Material Technology High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)
- 7.16.5 ShareX (Zhejiang) New Material Technology Recent Developments/Updates
- 7.16.6 ShareX (Zhejiang) New Material Technology Competitive Strengths & Weaknesses
- 7.17 Bando Chemical Industries
 - 7.17.1 Bando Chemical Industries Details
 - 7.17.2 Bando Chemical Industries Major Business
 - 7.17.3 Bando Chemical Industries High Thermal Conductivity Sintering Die Attach Adhesives Product and Services
 - 7.17.4 Bando Chemical Industries High Thermal Conductivity Sintering Die Attach Adhesives Production, Price, Value, Gross Margin and Market Share (2018-2023)
 - 7.17.5 Bando Chemical Industries Recent Developments/Updates
 - 7.17.6 Bando Chemical Industries Competitive Strengths & Weaknesses

8 INDUSTRY CHAIN ANALYSIS

- 8.1 High Thermal Conductivity Sintering Die Attach Adhesives Industry Chain
- 8.2 High Thermal Conductivity Sintering Die Attach Adhesives Upstream Analysis
 - 8.2.1 High Thermal Conductivity Sintering Die Attach Adhesives Core Raw Materials
 - 8.2.2 Main Manufacturers of High Thermal Conductivity Sintering Die Attach Adhesives Core Raw Materials
- 8.3 Midstream Analysis
- 8.4 Downstream Analysis
- 8.5 High Thermal Conductivity Sintering Die Attach Adhesives Production Mode
- 8.6 High Thermal Conductivity Sintering Die Attach Adhesives Procurement Model
- 8.7 High Thermal Conductivity Sintering Die Attach Adhesives Industry Sales Model and Sales Channels
 - 8.7.1 High Thermal Conductivity Sintering Die Attach Adhesives Sales Model
 - 8.7.2 High Thermal Conductivity Sintering Die Attach Adhesives Typical Customers

9 RESEARCH FINDINGS AND CONCLUSION

10 APPENDIX

10.1 Methodology

10.2 Research Process and Data Source

10.3 Disclaimer

List Of Tables

LIST OF TABLES

Table 1. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Region (2018, 2022 and 2029) & (USD Million)

Table 2. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Region (2018-2023) & (USD Million)

Table 3. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Region (2024-2029) & (USD Million)

Table 4. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value Market Share by Region (2018-2023)

Table 5. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value Market Share by Region (2024-2029)

Table 6. World High Thermal Conductivity Sintering Die Attach Adhesives Production by Region (2018-2023) & (Kg)

Table 7. World High Thermal Conductivity Sintering Die Attach Adhesives Production by Region (2024-2029) & (Kg)

Table 8. World High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share by Region (2018-2023)

Table 9. World High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share by Region (2024-2029)

Table 10. World High Thermal Conductivity Sintering Die Attach Adhesives Average Price by Region (2018-2023) & (US\$/g)

Table 11. World High Thermal Conductivity Sintering Die Attach Adhesives Average Price by Region (2024-2029) & (US\$/g)

Table 12. High Thermal Conductivity Sintering Die Attach Adhesives Major Market Trends

Table 13. World High Thermal Conductivity Sintering Die Attach Adhesives Consumption Growth Rate Forecast by Region (2018 & 2022 & 2029) & (Kg)

Table 14. World High Thermal Conductivity Sintering Die Attach Adhesives Consumption by Region (2018-2023) & (Kg)

Table 15. World High Thermal Conductivity Sintering Die Attach Adhesives Consumption Forecast by Region (2024-2029) & (Kg)

Table 16. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Manufacturer (2018-2023) & (USD Million)

Table 17. Production Value Market Share of Key High Thermal Conductivity Sintering Die Attach Adhesives Producers in 2022

Table 18. World High Thermal Conductivity Sintering Die Attach Adhesives Production

by Manufacturer (2018-2023) & (Kg)

Table 19. Production Market Share of Key High Thermal Conductivity Sintering Die Attach Adhesives Producers in 2022

Table 20. World High Thermal Conductivity Sintering Die Attach Adhesives Average Price by Manufacturer (2018-2023) & (US\$/g)

Table 21. Global High Thermal Conductivity Sintering Die Attach Adhesives Company Evaluation Quadrant

Table 22. World High Thermal Conductivity Sintering Die Attach Adhesives Industry Rank of Major Manufacturers, Based on Production Value in 2022

Table 23. Head Office and High Thermal Conductivity Sintering Die Attach Adhesives Production Site of Key Manufacturer

Table 24. High Thermal Conductivity Sintering Die Attach Adhesives Market: Company Product Type Footprint

Table 25. High Thermal Conductivity Sintering Die Attach Adhesives Market: Company Product Application Footprint

Table 26. High Thermal Conductivity Sintering Die Attach Adhesives Competitive Factors

Table 27. High Thermal Conductivity Sintering Die Attach Adhesives New Entrant and Capacity Expansion Plans

Table 28. High Thermal Conductivity Sintering Die Attach Adhesives Mergers & Acquisitions Activity

Table 29. United States VS China High Thermal Conductivity Sintering Die Attach Adhesives Production Value Comparison, (2018 & 2022 & 2029) & (USD Million)

Table 30. United States VS China High Thermal Conductivity Sintering Die Attach Adhesives Production Comparison, (2018 & 2022 & 2029) & (Kg)

Table 31. United States VS China High Thermal Conductivity Sintering Die Attach Adhesives Consumption Comparison, (2018 & 2022 & 2029) & (Kg)

Table 32. United States Based High Thermal Conductivity Sintering Die Attach Adhesives Manufacturers, Headquarters and Production Site (States, Country)

Table 33. United States Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Value, (2018-2023) & (USD Million)

Table 34. United States Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Value Market Share (2018-2023)

Table 35. United States Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2023) & (Kg)

Table 36. United States Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share (2018-2023)

Table 37. China Based High Thermal Conductivity Sintering Die Attach Adhesives Manufacturers, Headquarters and Production Site (Province, Country)

Table 38. China Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Value, (2018-2023) & (USD Million)

Table 39. China Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Value Market Share (2018-2023)

Table 40. China Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2023) & (Kg)

Table 41. China Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share (2018-2023)

Table 42. Rest of World Based High Thermal Conductivity Sintering Die Attach Adhesives Manufacturers, Headquarters and Production Site (States, Country)

Table 43. Rest of World Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Value, (2018-2023) & (USD Million)

Table 44. Rest of World Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Value Market Share (2018-2023)

Table 45. Rest of World Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2023) & (Kg)

Table 46. Rest of World Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share (2018-2023)

Table 47. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Type, (USD Million), 2018 & 2022 & 2029

Table 48. World High Thermal Conductivity Sintering Die Attach Adhesives Production by Type (2018-2023) & (Kg)

Table 49. World High Thermal Conductivity Sintering Die Attach Adhesives Production by Type (2024-2029) & (Kg)

Table 50. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Type (2018-2023) & (USD Million)

Table 51. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Type (2024-2029) & (USD Million)

Table 52. World High Thermal Conductivity Sintering Die Attach Adhesives Average Price by Type (2018-2023) & (US\$/g)

Table 53. World High Thermal Conductivity Sintering Die Attach Adhesives Average Price by Type (2024-2029) & (US\$/g)

Table 54. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Application, (USD Million), 2018 & 2022 & 2029

Table 55. World High Thermal Conductivity Sintering Die Attach Adhesives Production by Application (2018-2023) & (Kg)

Table 56. World High Thermal Conductivity Sintering Die Attach Adhesives Production by Application (2024-2029) & (Kg)

Table 57. World High Thermal Conductivity Sintering Die Attach Adhesives Production

Value by Application (2018-2023) & (USD Million)

Table 58. World High Thermal Conductivity Sintering Die Attach Adhesives Production

Value by Application (2024-2029) & (USD Million)

Table 59. World High Thermal Conductivity Sintering Die Attach Adhesives Average

Price by Application (2018-2023) & (US\$/g)

Table 60. World High Thermal Conductivity Sintering Die Attach Adhesives Average

Price by Application (2024-2029) & (US\$/g)

Table 61. Heraeus Basic Information, Manufacturing Base and Competitors

Table 62. Heraeus Major Business

Table 63. Heraeus High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 64. Heraeus High Thermal Conductivity Sintering Die Attach Adhesives

Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 65. Heraeus Recent Developments/Updates

Table 66. Heraeus Competitive Strengths & Weaknesses

Table 67. Kyocera Basic Information, Manufacturing Base and Competitors

Table 68. Kyocera Major Business

Table 69. Kyocera High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 70. Kyocera High Thermal Conductivity Sintering Die Attach Adhesives

Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 71. Kyocera Recent Developments/Updates

Table 72. Kyocera Competitive Strengths & Weaknesses

Table 73. Indium Basic Information, Manufacturing Base and Competitors

Table 74. Indium Major Business

Table 75. Indium High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 76. Indium High Thermal Conductivity Sintering Die Attach Adhesives Production

(Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 77. Indium Recent Developments/Updates

Table 78. Indium Competitive Strengths & Weaknesses

Table 79. Alpha Assembly Solutions Basic Information, Manufacturing Base and Competitors

Table 80. Alpha Assembly Solutions Major Business

Table 81. Alpha Assembly Solutions High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 82. Alpha Assembly Solutions High Thermal Conductivity Sintering Die Attach Adhesives Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 83. Alpha Assembly Solutions Recent Developments/Updates

Table 84. Alpha Assembly Solutions Competitive Strengths & Weaknesses

Table 85. Henkel Basic Information, Manufacturing Base and Competitors

Table 86. Henkel Major Business

Table 87. Henkel High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 88. Henkel High Thermal Conductivity Sintering Die Attach Adhesives Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 89. Henkel Recent Developments/Updates

Table 90. Henkel Competitive Strengths & Weaknesses

Table 91. Namics Basic Information, Manufacturing Base and Competitors

Table 92. Namics Major Business

Table 93. Namics High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 94. Namics High Thermal Conductivity Sintering Die Attach Adhesives Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 95. Namics Recent Developments/Updates

Table 96. Namics Competitive Strengths & Weaknesses

Table 97. Advanced Joining Technology Basic Information, Manufacturing Base and Competitors

Table 98. Advanced Joining Technology Major Business

Table 99. Advanced Joining Technology High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 100. Advanced Joining Technology High Thermal Conductivity Sintering Die Attach Adhesives Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 101. Advanced Joining Technology Recent Developments/Updates

Table 102. Advanced Joining Technology Competitive Strengths & Weaknesses

Table 103. Shenzhen Facemoore Technology Basic Information, Manufacturing Base and Competitors

Table 104. Shenzhen Facemoore Technology Major Business

Table 105. Shenzhen Facemoore Technology High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 106. Shenzhen Facemoore Technology High Thermal Conductivity Sintering Die

Attach Adhesives Production (Kg), Price (US\$/g), Production Value (USD Million),
Gross Margin and Market Share (2018-2023)

Table 107. Shenzhen Facemoore Technology Recent Developments/Updates

Table 108. Shenzhen Facemoore Technology Competitive Strengths & Weaknesses

Table 109. Beijing Nanotop Electronic Technology Basic Information, Manufacturing
Base and Competitors

Table 110. Beijing Nanotop Electronic Technology Major Business

Table 111. Beijing Nanotop Electronic Technology High Thermal Conductivity Sintering
Die Attach Adhesives Product and Services

Table 112. Beijing Nanotop Electronic Technology High Thermal Conductivity Sintering
Die Attach Adhesives Production (Kg), Price (US\$/g), Production Value (USD Million),
Gross Margin and Market Share (2018-2023)

Table 113. Beijing Nanotop Electronic Technology Recent Developments/Updates

Table 114. Beijing Nanotop Electronic Technology Competitive Strengths &
Weaknesses

Table 115. TANAKA Precious Metals Basic Information, Manufacturing Base and
Competitors

Table 116. TANAKA Precious Metals Major Business

Table 117. TANAKA Precious Metals High Thermal Conductivity Sintering Die Attach
Adhesives Product and Services

Table 118. TANAKA Precious Metals High Thermal Conductivity Sintering Die Attach
Adhesives Production (Kg), Price (US\$/g), Production Value (USD Million), Gross
Margin and Market Share (2018-2023)

Table 119. TANAKA Precious Metals Recent Developments/Updates

Table 120. TANAKA Precious Metals Competitive Strengths & Weaknesses

Table 121. Nihon Superior Basic Information, Manufacturing Base and Competitors

Table 122. Nihon Superior Major Business

Table 123. Nihon Superior High Thermal Conductivity Sintering Die Attach Adhesives
Product and Services

Table 124. Nihon Superior High Thermal Conductivity Sintering Die Attach Adhesives
Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and
Market Share (2018-2023)

Table 125. Nihon Superior Recent Developments/Updates

Table 126. Nihon Superior Competitive Strengths & Weaknesses

Table 127. Nihon Handa Basic Information, Manufacturing Base and Competitors

Table 128. Nihon Handa Major Business

Table 129. Nihon Handa High Thermal Conductivity Sintering Die Attach Adhesives
Product and Services

Table 130. Nihon Handa High Thermal Conductivity Sintering Die Attach Adhesives

Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 131. Nihon Handa Recent Developments/Updates

Table 132. Nihon Handa Competitive Strengths & Weaknesses

Table 133. NBE Tech Basic Information, Manufacturing Base and Competitors

Table 134. NBE Tech Major Business

Table 135. NBE Tech High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 136. NBE Tech High Thermal Conductivity Sintering Die Attach Adhesives Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 137. NBE Tech Recent Developments/Updates

Table 138. NBE Tech Competitive Strengths & Weaknesses

Table 139. Solderwell Advanced Materials Basic Information, Manufacturing Base and Competitors

Table 140. Solderwell Advanced Materials Major Business

Table 141. Solderwell Advanced Materials High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 142. Solderwell Advanced Materials High Thermal Conductivity Sintering Die Attach Adhesives Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 143. Solderwell Advanced Materials Recent Developments/Updates

Table 144. Solderwell Advanced Materials Competitive Strengths & Weaknesses

Table 145. Guangzhou Xianyi Electronic Technology Basic Information, Manufacturing Base and Competitors

Table 146. Guangzhou Xianyi Electronic Technology Major Business

Table 147. Guangzhou Xianyi Electronic Technology High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 148. Guangzhou Xianyi Electronic Technology High Thermal Conductivity Sintering Die Attach Adhesives Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 149. Guangzhou Xianyi Electronic Technology Recent Developments/Updates

Table 150. Guangzhou Xianyi Electronic Technology Competitive Strengths & Weaknesses

Table 151. ShareX (Zhejiang) New Material Technology Basic Information, Manufacturing Base and Competitors

Table 152. ShareX (Zhejiang) New Material Technology Major Business

Table 153. ShareX (Zhejiang) New Material Technology High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 154. ShareX (Zhejiang) New Material Technology High Thermal Conductivity Sintering Die Attach Adhesives Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 155. ShareX (Zhejiang) New Material Technology Recent Developments/Updates

Table 156. Bando Chemical Industries Basic Information, Manufacturing Base and Competitors

Table 157. Bando Chemical Industries Major Business

Table 158. Bando Chemical Industries High Thermal Conductivity Sintering Die Attach Adhesives Product and Services

Table 159. Bando Chemical Industries High Thermal Conductivity Sintering Die Attach Adhesives Production (Kg), Price (US\$/g), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 160. Global Key Players of High Thermal Conductivity Sintering Die Attach Adhesives Upstream (Raw Materials)

Table 161. High Thermal Conductivity Sintering Die Attach Adhesives Typical Customers

Table 162. High Thermal Conductivity Sintering Die Attach Adhesives Typical Distributors

List Of Figures

LIST OF FIGURES

- Figure 1. High Thermal Conductivity Sintering Die Attach Adhesives Picture
- Figure 2. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value: 2018 & 2022 & 2029, (USD Million)
- Figure 3. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value and Forecast (2018-2029) & (USD Million)
- Figure 4. World High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2029) & (Kg)
- Figure 5. World High Thermal Conductivity Sintering Die Attach Adhesives Average Price (2018-2029) & (US\$/g)
- Figure 6. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value Market Share by Region (2018-2029)
- Figure 7. World High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share by Region (2018-2029)
- Figure 8. North America High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2029) & (Kg)
- Figure 9. Europe High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2029) & (Kg)
- Figure 10. China High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2029) & (Kg)
- Figure 11. Japan High Thermal Conductivity Sintering Die Attach Adhesives Production (2018-2029) & (Kg)
- Figure 12. High Thermal Conductivity Sintering Die Attach Adhesives Market Drivers
- Figure 13. Factors Affecting Demand
- Figure 14. World High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029) & (Kg)
- Figure 15. World High Thermal Conductivity Sintering Die Attach Adhesives Consumption Market Share by Region (2018-2029)
- Figure 16. United States High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029) & (Kg)
- Figure 17. China High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029) & (Kg)
- Figure 18. Europe High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029) & (Kg)
- Figure 19. Japan High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029) & (Kg)

Figure 20. South Korea High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029) & (Kg)

Figure 21. ASEAN High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029) & (Kg)

Figure 22. India High Thermal Conductivity Sintering Die Attach Adhesives Consumption (2018-2029) & (Kg)

Figure 23. Producer Shipments of High Thermal Conductivity Sintering Die Attach Adhesives by Manufacturer Revenue (\$MM) and Market Share (%): 2022

Figure 24. Global Four-firm Concentration Ratios (CR4) for High Thermal Conductivity Sintering Die Attach Adhesives Markets in 2022

Figure 25. Global Four-firm Concentration Ratios (CR8) for High Thermal Conductivity Sintering Die Attach Adhesives Markets in 2022

Figure 26. United States VS China: High Thermal Conductivity Sintering Die Attach Adhesives Production Value Market Share Comparison (2018 & 2022 & 2029)

Figure 27. United States VS China: High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share Comparison (2018 & 2022 & 2029)

Figure 28. United States VS China: High Thermal Conductivity Sintering Die Attach Adhesives Consumption Market Share Comparison (2018 & 2022 & 2029)

Figure 29. United States Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share 2022

Figure 30. China Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share 2022

Figure 31. Rest of World Based Manufacturers High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share 2022

Figure 32. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Type, (USD Million), 2018 & 2022 & 2029

Figure 33. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value Market Share by Type in 2022

Figure 34. Pressure Sintering

Figure 35. Pressure-less Sintering

Figure 36. World High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share by Type (2018-2029)

Figure 37. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value Market Share by Type (2018-2029)

Figure 38. World High Thermal Conductivity Sintering Die Attach Adhesives Average Price by Type (2018-2029) & (US\$/g)

Figure 39. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value by Application, (USD Million), 2018 & 2022 & 2029

Figure 40. World High Thermal Conductivity Sintering Die Attach Adhesives Production

Value Market Share by Application in 2022

Figure 41. Power Semiconductor Device

Figure 42. RF Power Device

Figure 43. High Performance LED

Figure 44. Others

Figure 45. World High Thermal Conductivity Sintering Die Attach Adhesives Production Market Share by Application (2018-2029)

Figure 46. World High Thermal Conductivity Sintering Die Attach Adhesives Production Value Market Share by Application (2018-2029)

Figure 47. World High Thermal Conductivity Sintering Die Attach Adhesives Average Price by Application (2018-2029) & (US\$/g)

Figure 48. High Thermal Conductivity Sintering Die Attach Adhesives Industry Chain

Figure 49. High Thermal Conductivity Sintering Die Attach Adhesives Procurement Model

Figure 50. High Thermal Conductivity Sintering Die Attach Adhesives Sales Model

Figure 51. High Thermal Conductivity Sintering Die Attach Adhesives Sales Channels, Direct Sales, and Distribution

Figure 52. Methodology

Figure 53. Research Process and Data Source

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